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- Equivalent Input Noise Voltage . . . 3.5 nV/√Hz Typ
- Unity-Gain Bandwidth . . . 10 MHz Typ
- Common-Mode Rejection Ratio . . . 100 dB Typ
- High DC Voltage Gain . . . 100 V/mV Typ
- Peak-to-Peak Output Voltage Swing 32 V Typ With V_{CC±} = ±18 V and R_L = 600 Ω
- High Slew Rate ... 13 V/μs Typ
- Wide Supply-Voltage Range ±3 V to ±20 V
- Low Harmonic Distortion
- Offset Nulling Capability
- External Compensation Capability

description/ordering information

NE5534, SA5534 . . . D (SOIC), P (PDIP), **OR PS (SOP) PACKAGE** NE5534A, SA5534A . . . D (SOIC) OR P (PDIP) PACKAGE (TOP VIEW) 8 COMP/BAL BALANCE [IV_{CC+} IN-2 7 IN+ 🛛 3 5 4 COMP Vcc

The NE5534, NE5534A, SA5534, and SA5534A are high-performance operational amplifiers combining excellent dc and ac characteristics. Some of the features include very low noise, high output-drive capability, high unity-gain and maximum-output-swing bandwidths, low distortion, and high slew rate.

These operational amplifiers are compensated internally for a gain equal to or greater than three. Optimization of the frequency response for various applications can be obtained by use of an external compensation capacitor between COMP and COMP/BAL. The devices feature input-protection diodes, output short-circuit protection, and offset-voltage nulling capability with use of the BALANCE and COMP/BAL pins (see the *application circuit* diagram).

For the NE5534A and SA5534A, a maximum limit is specified for the equivalent input noise voltage.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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description/ordering information (continued)

| TA | V _{IO} max AT 25°C | PACKA | GE† | ORDERABLE PART NUMBER | TOP-SIDE MARKING | | |
|---------------|--------------------------------|----------|--------------|--------------------------|---------------------|--|--|
| | | | Tube of 50 | NE5534P | NE5534P | | |
| | | PDIP (P) | Tube of 50 | NE5534AP | NE5534AP | | |
| | | SOIC (D) | Tube of 75 | NE5534D | | | |
| 0°C to 70°C | 4 mV | | Reel of 2500 | NE5534DR | NE5534 | | |
| | | | Tube of 75 | NE5534AD | 55044 | | |
| | | | Reel of 2500 | NE5534ADR | 5534A | | |
| | | SOP (PS) | Reel of 2000 | NE5534PSR | N5534 | | |
| | 4 mV | PDIP (P) | Tube of 50 | SA5534P | SA5534P | | |
| | | | Tube of 50 | SA5534AP | SA5534AP | | |
| | | | Tube of 75 | SA5534D | 045504 | | |
| 4000 4 0500 | | SOIC (D) | Reel of 2500 | SA5534DR | SA5534 | | |
| –40°C to 85°C | | | Tube of 75 | SA5534AD | SA5534A | | |
| | | | Reel of 2500 | SA5534ADR | 5A5534A | | |
| | | 000 (00) | Tube of 80 | SA553APS | SA5524 | | |
| | | SOP (PS) | Reel of 2000 | SA553APSR | SA5534 | | |

ORDERING INFORMATION

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

schematic



All component values shown are nominal.



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symbol



Frequency Compensation and Offset-Voltage Nulling Circuit

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| Supply voltage: V _{CC+} (see Note 1) | | 22 V |
|---|------------|------------------|
| V _{CC} (see Note 1) | | 22 V |
| Input voltage either input (see Notes 1 and 2) | | V _{CC+} |
| Input current (see Note 3) | | ±10 mA |
| Duration of output short circuit (see Note 4) | | Unlimited |
| Package thermal impedance, θ_{JA} (see Notes 5 and 6): | D package | 97°C/W |
| | P package | 85°C/W |
| | PS package | 95°C/W |
| Operating virtual junction temperature, T _J | | 150°C |
| Storage temperature range, T _{stg} | | |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+} and V_{CC-}.
 - 2. The magnitude of the input voltage must never exceed the magnitude of the supply voltage.
 - 3. Excessive current will flow if a differential input voltage in excess of approximately 0.6 V is applied between the inputs, unless some limiting resistance is used.
 - 4. The output may be shorted to ground or to either power supply. Temperature and/or supply voltages must be limited to ensure the maximum dissipation rating is not exceeded.
 - 5. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - 6. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

| | | | MIN | MAX | UNIT | |
|-------------------|--------------------------------------|-----------------|-----|-----|------|--|
| V _{CC+} | Supply voltage | | 5 | 15 | V | |
| V _{CC} - | V _{CC} - Supply voltage | | | | V | |
| T . | | NE5534, NE5534A | 0 | 70 | °C | |
| TA | Operating free-air temperature range | SA5534, SA5534A | -40 | 85 | -0 | |



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electrical characteristics, V_CC \pm = ± 15 V, T_A = 25°C (unless otherwise noted)

| PARAMETER | | TEST CONDI | MIN | TYP | MAX | UNIT | | |
|------------------|--|--|---------------------------------------|-----|-----|--------|------|--|
| | hand all a facility of | $V_{O} = 0,$ | $T_A = 25^{\circ}C$ | | 0.5 | 4 | | |
| VIO | Input offset voltage | $R_{S} = 50 \Omega$ | T _A = Full range | | | 5 | mV | |
| | hand all and a summer to | | $T_A = 25^{\circ}C$ | | 20 | 300 | nA | |
| lio | Input offset current | V _O = 0 | T _A = Full range | | | 400 | | |
| l | Input high ourrest | N- 0 | $T_A = 25^{\circ}C$ | | 500 | 1500 | | |
| I _{IB} | Input bias current | V _O = 0 | T _A = Full range | | | 2000 | nA | |
| VICR | Common-mode input voltage range | | | ±12 | ±13 | | V | |
| | Movimum pools to pools output voltogo output | $P_{\rm c} > 600 O$ | $V_{CC\pm} = \pm 15 V$ | 24 | 26 | | v | |
| VO(PP) | Maximum peak-to-peak output voltage swing | $R_L \ge 600 \Omega$ | $V_{CC\pm} = \pm 18 \text{ V}$ | 30 | 32 | | | |
| A | Large-signal differential voltage amplification | $V_{O} = \pm 10 \text{ V},$ $R_{L} \ge 600 \Omega$ | $T_A = 25^{\circ}C$ | 25 | 100 | | V/mV | |
| AVD | | | T _A = Full range | 15 | | | | |
| • | Cmall signal differential voltage emplification | f = 10 kHz | $C_{C} = 0$ | | 6 | | V/mV | |
| A _{vd} | Small-signal differential voltage amplification | | C _C = 22 pF | | 2.2 | 2 0/mV | | |
| | Maximum-output-swing bandwidth | V _O = ±10 V | CC = 0 | | 200 | | kHz | |
| Вом | | | C _C = 22 pF | | 95 | | | |
| DOM | | | | | 70 | | | |
| B ₁ | Unity-gain bandwidth | C _C = 22 pF, | $C_L = 100 \text{ pF}$ | | 10 | | MHz | |
| r _i | Input resistance | | | 30 | 100 | | kΩ | |
| z ₀ | Output impedance | $A_{VD} = 30 \text{ dB},$ $C_C = 22 \text{ pF},$ | R _L ≥ 600 Ω, f = 10 kHz | | 0.3 | | Ω | |
| CMRR | Common-mode rejection ratio | $V_{O} = 0,$ R _S = 50 Ω | $V_{IC} = V_{ICR}min$ | 70 | 100 | | dB | |
| ^k SVR | Supply-voltage rejection ratio ($\Delta V_{CC} / \Delta V_{IO}$) | $V_{CC+} = \pm 9 V \text{ to } \pm 15 V,$ $V_{O} = 0$ | R _S = 50 Ω, | 80 | 100 | | dB | |
| los | Output short-circuit current | | | | 38 | | mA | |
| ICC | Supply current | $V_{O} = 0$, No load | T _A = 25°C | | 4 | 8 | mA | |

[†] All characteristics are measured under open-loop conditions with zero common-mode input voltage, unless otherwise specified. For NE5534 and NE5534A, full range is 0°C to 70°C. For SA5534 and SA5534A, full range is –40°C to 85°C.



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| operating characteristics, | $V_{CC} \pm = \pm 15 V, T_{A} = 25^{\circ}C$ |
|----------------------------|--|
|----------------------------|--|

| PARAMETER | | TEST CONDITIONS | NE5534, SA5534 | NE5534A, SA | UNIT | | |
|-----------|--------------------------------|--|-------------------|-------------|------|--------|--|
| | | | ТҮР | MIN TYP | MAX | | |
| 0.0 | | $C_{C} = 0$ | 13 | 13 | | | |
| SR | Slew rate | C _C = 22 pF | 6 | 6 | V/µs | | |
| | Rise time | $V_{I} = 50 \text{ mV}, A_{VD} = 1,$ | 20 | 20 | | ns | |
| | Overshoot factor | $R_L = 600 \Omega$, $C_C = 22 pF$ $C_L = 100 pF$ | 20 | 20 | | % | |
| tr | Rise time | $V_{I} = 50 \text{ mV}, A_{VD} = 1,$ | 50 | 50 | | ns | |
| | Overshoot factor | $R_L = 600 \Omega$, $C_C = 47 pF$ $C_L = 500 pF$ | 35 | 35 | | % | |
| V | | f = 30 Hz | 7 | 5.5 | 7 | | |
| Vn | Equivalent input noise voltage | f = 1 kHz | 4 | 3.5 | 4.5 | nV/√Hz | |
| | | f = 30 Hz | 2.5 | 1.5 | | | |
| In | Equivalent input noise current | f = 1 kHz | 0.6 | 0.4 | | pA/√Hz | |
| F | Average noise figure | $R_S = 5 k\Omega$, $f = 10 Hz$ to 20 kHz | | 0.9 | | dB | |



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TYPICAL CHARACTERISTICS[†]

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



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TYPICAL CHARACTERISTICS[†]

[†] Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.



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TYPICAL CHARACTERISTICS



4-Mar-2005

PACKAGING INFORMATION

Τενδε

www.ti.com

JMENTS

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|-------------------------|------------------|--|
| NE5534AD | ACTIVE | SOIC | D | 8 | 75 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR |
| NE5534ADR | ACTIVE | SOIC | D | 8 | 2500 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR |
| NE5534AJG | OBSOLETE | CDIP | JG | 8 | | None | Call TI | Call TI |
| NE5534AP | ACTIVE | PDIP | Ρ | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| NE5534D | ACTIVE | SOIC | D | 8 | 75 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR |
| NE5534DR | ACTIVE | SOIC | D | 8 | 2500 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR |
| NE5534IP | OBSOLETE | PDIP | Р | 8 | | None | Call TI | Call TI |
| NE5534P | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| NE5534PSR | ACTIVE | SO | PS | 8 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| SA5534AD | ACTIVE | SOIC | D | 8 | 75 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SA5534ADR | ACTIVE | SOIC | D | 8 | 2500 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SA5534AP | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SA5534D | ACTIVE | SOIC | D | 8 | 75 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SA5534DR | ACTIVE | SOIC | D | 8 | 2500 | Pb-Free (RoHS) | CU NIPDAU | Level-2-250C-1 YEAR/ Level-1-235C-UNLIM |
| SA5534P | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | Level-NC-NC-NC |
| SA5534PS | ACTIVE | SO | PS | 8 | 80 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |
| SA5534PSR | ACTIVE | SO | PS | 8 | 2000 | Pb-Free (RoHS) | CU NIPDAU | Level-2-260C-1 YEAR/ Level-1-235C-UNLIM |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.



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MECHANICAL DATA

MCER001A - JANUARY 1995 - REVISED JANUARY 1997



CERAMIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8



MECHANICAL DATA

MPDI001A - JANUARY 1995 - REVISED JUNE 1999



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm



D (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AA.



MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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